

**SE2302**  
**3A,20V N-Channel MOSFET**

Revision:A

**General Description**

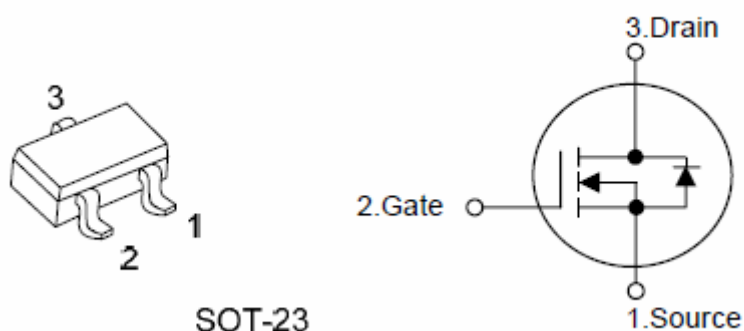
The MOSFETs from SINO-IC provide the best combination of fast switching, low on-resistance and cost-effectiveness.

**Features**

- $V_{DS}$  (V) = 20V
- $I_D$  = 3A
- $R_{DS(ON)} < 60m\Omega$  ( $V_{GS} = 4.5V$ )

**Pin configurations**

See Diagram below



**Absolute Maximum Ratings**

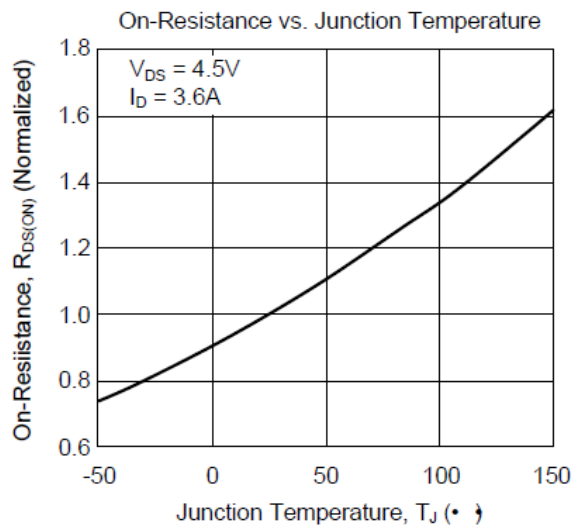
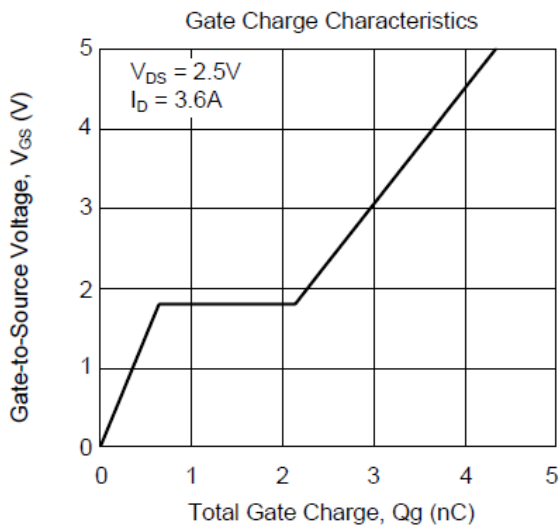
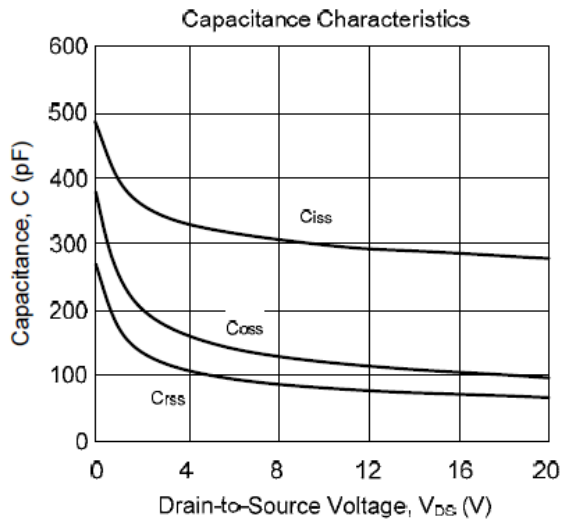
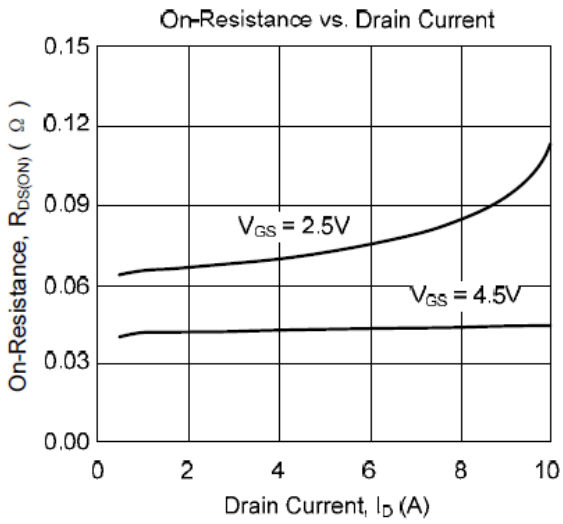
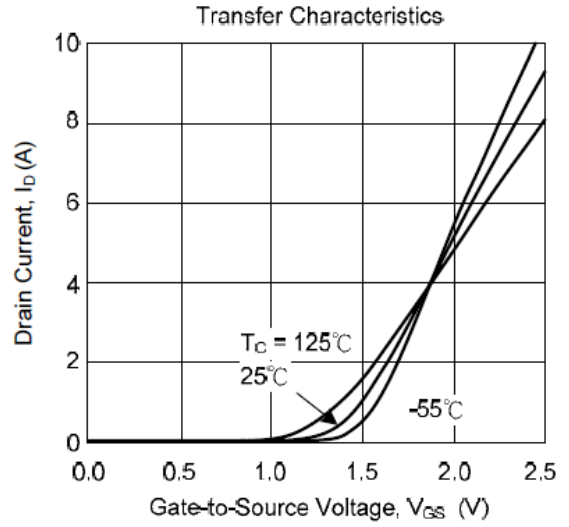
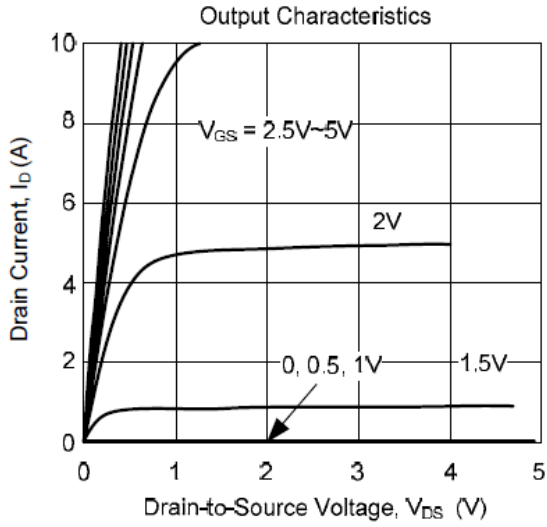
Parameter		Symbol	Rating	Units
Drain-Source Voltage		$V_{DS}$	20	V
Gate-Source Voltage		$V_{GS}$	$\pm 8$	V
Drain Current (Note 1)	Continuous	$I_D$	3	A
	Pulsed		9	
Total Power Dissipation		$P_D$	1.25	W
Operating Junction Temperature Range		$T_J$	-50 to 150	$^{\circ}C$

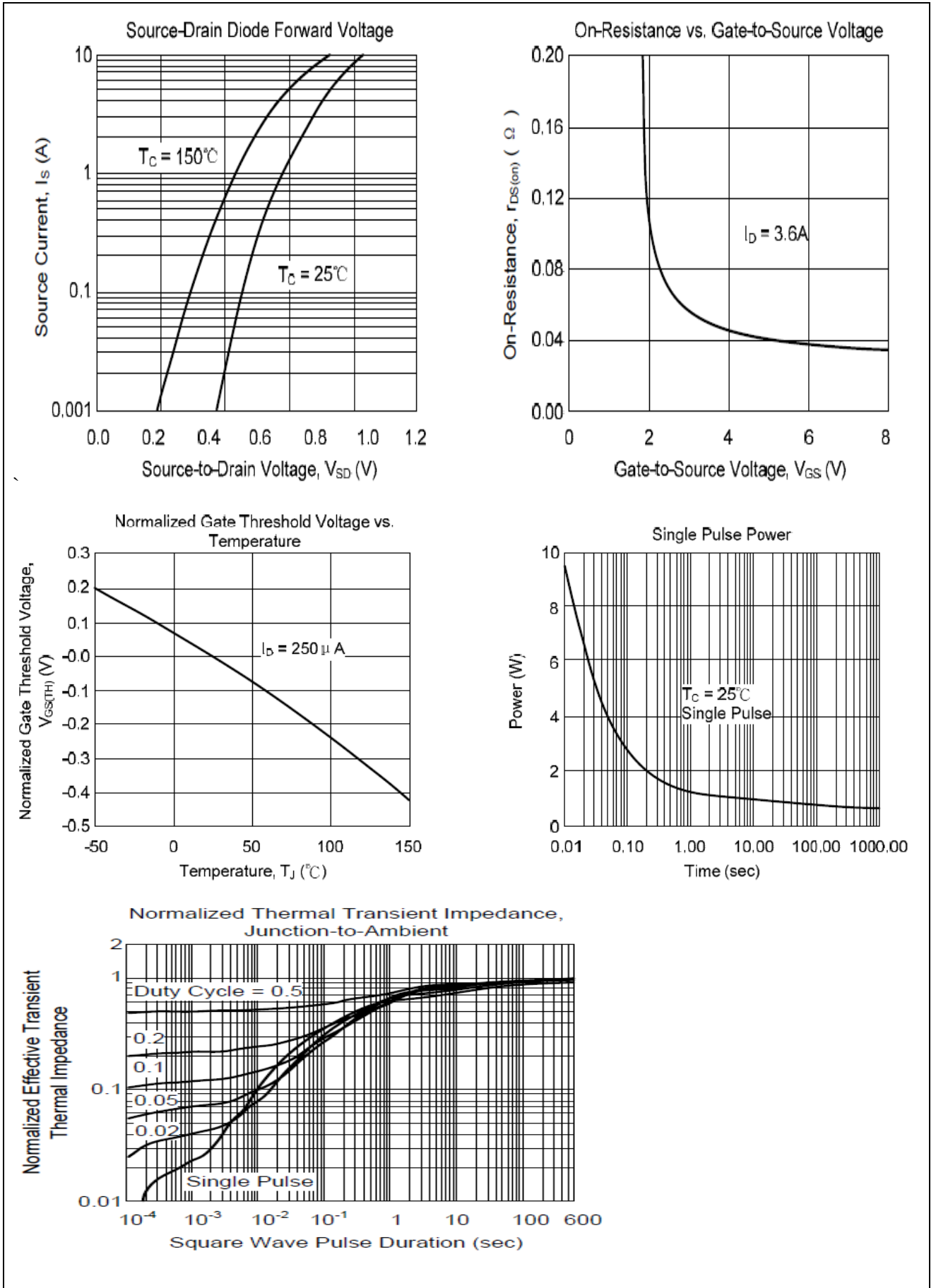
**Thermal Characteristics**

Parameter		Symbol	Typ	Max	Units
Maximum Junction-to-Ambient $\theta_{JA}$	$t \leq 10s$	$\theta_{JA}$	-	100	$^{\circ}C/W$

Electrical Characteristics (T <sub>J</sub> =25°C unless otherwise noted)						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>OFF/ON CHARACTERISTICS (Note 2)</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> =250 μ A, V <sub>GS</sub> =0 V	20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =20 V, V <sub>GS</sub> =0 V			1	μ A
I <sub>GSS</sub>	Gate-Body leakage current	V <sub>DS</sub> =0 V, V <sub>GS</sub> =±8 V			100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> I <sub>D</sub> =250 μ A	0.6	-	1.2	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =2.8A	-	43	60	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =2.0A		52	115	mΩ
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =2.0A		80	130	mΩ
<b>DYNAMIC PARAMETERS</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =10V, f=1MHz		450		pF
C <sub>oss</sub>	Output Capacitance			70		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			43		pF
TON	Turn-On Time	V <sub>DS</sub> =10V, I <sub>D</sub> = 1A, V <sub>GS</sub> =4.5 V, R <sub>GEN</sub> =6 Ω	-	7	15	ns
TOFF	Turn-Off Time		-	16	60	ns
Tr	Turn-on Rise Time		-	55	80	ns
Tf	Turn-on Fall Time		-	20	25	ns
Q <sub>g(10)</sub>	Total Gate Charge	V <sub>DS</sub> =10V, I <sub>D</sub> =3.6A, V <sub>GS</sub> =4.5V		5.2	10	nC
Q <sub>gs</sub>	Gate-Source Charge			0.65	.	nC
Q <sub>gd</sub>	Gate-Drain Charge			1.5		nC
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> =0 V, I <sub>S</sub> =1.0 A		0.76	1.2	V
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				1.6	A

# Typical Characteristics





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